

Notice of References Cited	Application/Control No. 10/590,446	Applicant(s)/Patent Under Reexamination FORGACS ET AL.	
	Examiner KAILASH C. SRIVASTAVA,	Art Unit 1653	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-			
	B	US-			
	C	US-			
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	I					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Tang et al. 2003. Molding of Three-Dimensional Microstructures of Gels. Journal of American Chemical Society (i.e., J. AM. CHEM. SOC.), Volume 125, Number 43, Pages 12988-12989.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.